L Number	Hits	Search Text	DB	Time stamp
6	256	(directional adj coupler) and substrate	USPAT;	2003/10/15 18:45
		and transformer	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
7	211		USPAT;	2003/10/15 17:37
		ceramic	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
8	20	(low adj temperature adj cofired adj	IBM_TDB USPAT;	2003/10/15 17:40
	20	ceramic) and transformer	US-PGPUB;	2003, 10, 13 1, 10
		Columno, and clamblolmer	EPO; JPO;	
			DERWENT;	
			IBM TDB	
9	19	(ltcc adj substrate) and transformer	USPAT;	2003/10/15 17:43
		-	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0000/10/15 15 45
11	4	resistor with transformer with capacitor	USPAT;	2003/10/15 17:45
		with vias with substrate	US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM TDB	
12	39	resistor same transformer same capacitor	USPAT;	2003/10/15 17:49
12	33	same vias same substrate	US-PGPUB;	2003, 10, 13 1, 113
		Same Vias Same Sasserate	EPO; JPO;	
			DERWENT;	
			IBM TDB	
13	3	coupler same transformer same capacitor	USPĀT;	2003/10/15 17:50
		same vias same substrate	US-PGPUB;	
			EPO; JPO;	•
			DERWENT;	
14	120	tuan afarman adi subat nata	IBM_TDB USPAT;	2003/10/15 17:56
14	138	transformer adj substrate	US-PGPUB;	2003/10/13 17.30
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
15	6	transformer adj attached adj substrate	USPAT;	2003/10/15 17:57
		•	US-PGPUB;	
			EPO; JPO;	+
			DERWENT;	
	0.1		IBM_TDB	0000/10/15 17 50
16	21	transformer adj mounted adj substrate	USPAT;	2003/10/15 17:58
			US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM TDB	
17	211	transformer near substrate	USPAT;	2003/10/15 19:34
	-		US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0000/10/10/10
18	512	inductor near substrate	USPAT;	2003/10/15 18:03
			US-PGPUB;	
			EPO; JPO; DERWENT;	
		÷	IBM TDB	
19	6	(directional adj coupler) and (binocular	USPAT;	2003/10/15 18:47
	5	adj core)	US-PGPUB;	
		, · · · · · · · · · · · · · · · · · · ·	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
20	0	(directional adj coupler) and (low adj	USPAT;	2003/10/15 18:48
		temperature adj cofired adj ceramic adj	US-PGPUB;	
		substrate)	EPO; JPO;	
l			DERWENT; IBM TDB	
· !				

	,			
21	1	(directional adj coupler) and (low adj temperature adj co adj fired adj ceramic	USPAT; US-PGPUB;	2003/10/15 18:48
		adi substrate)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
22	5		USPAT;	2003/10/15 18:50
		temperature adj co adj fired adj ceramic)	US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
23	28	(coupler) and (low adj temperature adj co	USPAT;	2003/10/15 18:50
		adj fired adj ceramic)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
24	_	transformer near (reflow adj solder adj	IBM_TDB USPAT;	2003/10/15 19:35
24		paste)	US-PGPUB;	2003/10/13 19.33
		puscey	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
25	0	transformer adj (reflow adj solder adj	USPAT;	2003/10/15 19:35
	ļ	paste)	US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
26	0	transformer with (reflow adj solder adj	USPAT;	2003/10/15 19:35
		paste)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
27		transformer same (reflex add solder add	IBM_TDB USPAT;	2003/10/15 19:35
2 /	ĺ	transformer same (reflow adj solder adj paste)	US-PGPUB;	2003/10/13 19:33
	ĺ	paster	EPO; JPO;	
			DERWENT;	
	_		IBM_TDB	
28	3	transformer and (reflow adj solder adj	USPAT;	2003/10/15 19:55
		paste)	US-PGPUB; EPO; JPO;	
			DERWENT;	
	İ		IBM TDB	
29	0		USPAT;	2003/10/15 19:37
		solder adj paste)	US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
30	О .	5015972.pn. and resistor	USPĀT;	2003/10/15 19:55
		_	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
31	0	5015972.pn. and resistance	IBM_TDB USPAT;	2003/10/15 20:15
		Joseph and Tobiotanoc	US-PGPUB;	2000, 20, 10
			EPO; JPO;	
			DERWENT;	
20		(1,1,2,2,6,2,1,1,2,2,2,2,2,2,2,2,2,2,2,2,	IBM_TDB	2002/10/15 00 15
32	0	(transformer adj attached) near epoxy	USPAT;	2003/10/15 20:17
			US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM_TDB	
33	0	(transformer adj attached) adj epoxy	USPAT;	2003/10/15 20:16
			US-PGPUB;	
	1		EPO; JPO; DERWENT;	
ļ			IBM TDB	
34	3	(transformer adj attached) same epoxy	USPAT;	2003/10/15 20:16
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
L			IBM_TDB	l

				0000/10/15 00 16
35	3	(transformer adj attached) with epoxy	USPAT;	2003/10/15 20:16
			US-PGPUB;	
			EPO; JPO; DERWENT;	·
			1	
0.5	2.4		IBM_TDB	2002/10/15 20-21
36	34	(transformer) near epoxy	USPAT; US-PGPUB;	2003/10/15 20:21
			i i	
!			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0000/10/15 00 01
37	29	(transformer) adj epoxy	USPAT;	2003/10/15 20:21
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
38	844	(transformer) with epoxy	USPAT;	2003/10/15 20:22
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	1
			IBM_TDB	
39	26	(transformer) with epoxy with substrate	USPAT;	2003/10/15 20:40
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
40	7	resistor adj overglaze	USPAT;	2003/10/15 20:41
		·	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
}			IBM_TDB	
41	2	(resistor adj overglaze) and (coupler or	USPAT;	2003/10/15 20:41
		transformer)	US-PGPUB;	
	,		EPO; JPO;	•
			DERWENT;	
			IBM_TDB	
42	6	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	USPAT;	2003/10/15 20:59
		adj core)	US-PGPUB;	
			EPO; JPO;	
		+	DERWENT;	
			IBM_TDB	
43	1047	(directional adj coupler) and transformer	USPAT;	2003/10/15 20:47
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
44	3031	333/\$.ccls. and coupler	USPAT;	2003/10/15 21:01
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
45	512	333/\$.ccls. and coupler and transformer	USPAT;	2003/10/15 21:01
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	